

L Number	Hits	Search Text	DB	Time stamp
1	585	electroless adj copper adj plating adj bath	USPAT; EPO; JPO; DERWENT; USOCR	2004/01/14 11:26
2	49	((electroless adj copper adj plating adj bath) and (electroless adj copper adj solution))	USPAT; EPO; JPO; DERWENT; USOCR	2004/01/14 11:28
3	5	((electroless adj copper adj plating adj bath) and (electroless adj copper adj solution)) and (alkaline near earth)	USPAT; EPO; JPO; DERWENT; USOCR	2004/01/14 11:29
4	0	((electroless adj copper adj plating adj bath) and (electroless adj copper adj solution)) and (alkaline near earth)) and filter	USPAT; EPO; JPO; DERWENT; USOCR	2004/01/14 11:29
5	9	((electroless adj copper adj plating adj bath) and (electroless adj copper adj solution)) and filter	USPAT; EPO; JPO; DERWENT; USOCR	2004/01/14 11:29
6	6	((electroless adj copper adj plating adj bath) and (electroless adj copper adj solution)) and filter) and (machine or apparatus or tool)	USPAT; EPO; JPO; DERWENT; USOCR	2004/01/14 12:12
7	3	("4289597"   "4549946"   "4600493").PN.	USPAT	2004/01/14 11:34
8	13	4289597.URPN.	USPAT	2004/01/14 11:39
9	176	(electroless adj copper adj plating adj bath) and (machine or apparatus or tool)	USPAT; EPO; JPO; DERWENT; USOCR	2004/01/14 12:12
10	0	((electroless adj copper adj plating adj bath) and (machine or apparatus or tool)) and (filter adj unit)	USPAT; EPO; JPO; DERWENT; USOCR	2004/01/14 12:13
11	0	(electroless adj copper adj plating adj bath) and (filter adj unit)	USPAT; EPO; JPO; DERWENT; USOCR	2004/01/14 12:13
12	38	((electroless adj copper adj plating adj bath) and (machine or apparatus or tool)) and filter	USPAT; EPO; JPO; DERWENT; USOCR	2004/01/14 12:13
13	24	((electroless adj copper adj plating adj bath) and (machine or apparatus or tool)) and filter) and alkaline	USPAT; EPO; JPO; DERWENT; USOCR	2004/01/14 12:14
14	0	((electroless adj copper adj plating adj bath) and (machine or apparatus or tool)) and filter) and oreprecipitate	USPAT; EPO; JPO; DERWENT; USOCR	2004/01/14 12:16
15	0	precipitate adj sulfuric	USPAT; EPO; JPO; DERWENT; USOCR	2004/01/14 12:17
16	7	((electroless adj copper adj plating adj bath) and (machine or apparatus or tool)) and filter) and precipitate	USPAT; EPO; JPO; DERWENT; USOCR	2004/01/14 12:16
17	108	precipitate adj sulfuric	USPAT; EPO; JPO; DERWENT; USOCR	2004/01/14 12:17

18	3	(precipitate adj sulfuric) and (alkaline near metal)	USPAT; EPO; JPO; DERWENT; USOCR	2004/01/14 12:18
19	0	((precipitate adj sulfuric) and (alkaline near metal)) and electroless	USPAT; EPO; JPO; DERWENT; USOCR	2004/01/14 12:18

L Number	Hits	Search Text	DB	Time stamp
1	585	electroless adj copper adj plating adj bath	USPAT; EPO; JPO; DERWENT; USOCR	2004/01/14 11:26
2	49	(electroless adj copper adj plating adj bath) and (electroless adj copper adj solution)	USPAT; EPO; JPO; DERWENT; USOCR	2004/01/14 11:28
3	5	((electroless adj copper adj plating adj bath) and (electroless adj copper adj solution)) and (alkaline near earth)	USPAT; EPO; JPO; DERWENT; USOCR	2004/01/14 11:29
4	0	((((electroless adj copper adj plating adj bath) and (electroless adj copper adj solution)) and (alkaline near earth)) and filter	USPAT; EPO; JPO; DERWENT; USOCR	2004/01/14 11:29
5	9	((electroless adj copper adj plating adj bath) and (electroless adj copper adj solution)) and filter	USPAT; EPO; JPO; DERWENT; USOCR	2004/01/14 11:29
6	6	((((electroless adj copper adj plating adj bath) and (electroless adj copper adj solution)) and filter) and (machine or apparatus or tool)	USPAT; EPO; JPO; DERWENT; USOCR	2004/01/14 11:29
7	3	("4289597"   "4549946"   "4600493").PN.	USPAT	2004/01/14 11:34
8	13	4289597.URPN.	USPAT	2004/01/14 11:39